

P-223 I-MIL DOUBLE-COATED POLYIMIDE FILM TAPE, AMBER

APPLICATION

Provides outstanding thermal endurance and tensile strength at elevated temperatures. An ideal tape **for die-cutting.** Excellent **for splices of insulation layers.**

Often laminated to metal foils **to form pressure-sensitive EMI and RFI shields**, and to other high temperature insulations to make them pressure-sensitive. Ideal **for bonding and laminating** applications that require positive dielectric separation.

Available with easy-to-remove, heavy-duty treated cloth interliner. Also used for positioning coil terminal boards.

FEATURES AND BENEFITS

- Provides unique properties of polyimide adhesive tapes in double-coated form: outstanding thermal endurance, thinness, conformability, excellent puncture and tear resistance, and aggressive, solvent resistant adhesion.
- Perfect tape where both surfaces in a laminating and/or bonding application are silicone treated or coated.
- Non-corrosive nature permits use with ultra-fine magnet wire.
- · High dielectric strength permits use in high voltage areas with minimum insulation build-up.
- UL component recognized under File E20392.

TECHNICAL DATA

Insulation class 180° C

Backing material I-mil polyimide film
Adhesive Silicone, cured, interlined

Total tape thickness 4.5 mils/0.114 mm

Color Amber

Adhesion to steel 18 oz. per in./200 gm per cm

Tensile strength 25 lbs. per in./4.5 kg per cm

Dielectric strength 8,500 volts Elongation 50%

Flammability rating Complies with/UL-510 Test

UL component recog. Guide OANZ2, File E20392

Note: The above are typical values and should not be used in writing specifications.

STOCK SIZES

Refer to current Electronic Division Price List.